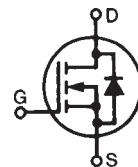


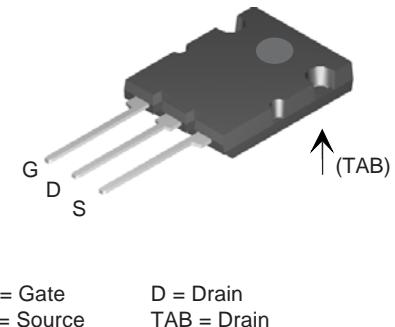
PolarHV™ HiPerFET IXFB 100N50P Power MOSFET

N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode

$V_{DSS} = 500$ V
 $I_{D25} = 100$ A
 $R_{DS(on)} \leq 49$ mΩ
 $t_{rr} \leq 200$ ns



| Symbol | Test Conditions | Maximum Ratings | | PLUS264™ (IXFB) |
|------------|--|-------------------|------|-----------------|
| V_{DSS} | $T_J = 25^\circ\text{C}$ to 150°C | 500 | V | |
| V_{DGR} | $T_J = 25^\circ\text{C}$ to 150°C ; $R_{GS} = 1$ MΩ | 500 | V | |
| V_{GSS} | Continuous | ±30 | V | |
| V_{GSM} | Transient | ±40 | V | |
| I_{D25} | $T_c = 25^\circ\text{C}$ | 100 | A | |
| I_{DRMS} | External lead current limit | 75 | A | |
| I_{DM} | $T_c = 25^\circ\text{C}$, pulse width limited by T_{JM} | 250 | A | |
| I_{AR} | $T_c = 25^\circ\text{C}$ | 100 | A | |
| E_{AR} | $T_c = 25^\circ\text{C}$ | 100 | mJ | |
| E_{AS} | $T_c = 25^\circ\text{C}$ | 5 | J | |
| dv/dt | $I_s \leq I_{DM}$, $di/dt \leq 100$ A/μs, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ\text{C}$, $R_G = 2$ Ω | 20 | V/ns | |
| P_D | $T_c = 25^\circ\text{C}$ | 1250 | W | |
| T_J | | -55 ... +150 | °C | |
| T_{JM} | | 150 | °C | |
| T_{stg} | | -55 ... +150 | °C | |
| T_L | Maximum lead temperature for soldering 1.6 mm (0.062 in.) from case for 10 s | 300 | °C | |
| F_c | Mounting force | 30..120/7.5...2.7 | N/lb | |
| Weight | | 10 | g | |



G = Gate D = Drain
S = Source TAB = Drain

Features

- International standard packages
- Fast recovery diode
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
 - easy to drive and to protect

Advantages

- Plus 264™ package for clip or spring
- Space savings
- High power density

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified) | Characteristic Values | | |
|--------------|---|-----------------------|------|------------------|
| | | Min. | Typ. | Max. |
| V_{DSS} | $V_{GS} = 0$ V, $I_D = 3$ mA | 500 | | V |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 8$ mA | 3.0 | | 5.0 V |
| I_{GSS} | $V_{GS} = \pm 30$ V _{DC} , $V_{DS} = 0$ | | | ±200 nA |
| I_{DSS} | $V_{DS} = V_{DSS}$ $V_{GS} = 0$ V | | | 25 μA 2000 μA |
| $R_{DS(on)}$ | $V_{GS} = 10$ V, $I_D = 0.5 I_{D25}$, Note 1 | | | 49 mΩ |

Symbol **Test Conditions****Characteristic Values**(T_J = 25°C, unless otherwise specified)

Min. | Typ. | Max.

| | | | | |
|---|---|------|------|-----|
| g_{fs} | V _{DS} = 20 V; I _D = 0.5 I _{D25} , Note 1 | 50 | 80 | S |
| C_{iss} C_{oss} C_{rss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz | 20 | nF | |
| | | 1700 | pF | |
| | | 140 | pF | |
| t_{d(on)} t_r t_{d(off)} t_f | V _{GS} = 10 V, V _{DS} = 0.5 V _{DSS} , I _D = 0.5 I _{D25} R _G = 1 Ω (External) | 36 | ns | |
| | | 29 | ns | |
| | | 110 | ns | |
| | | 26 | ns | |
| Q_{g(on)} Q_{gs} Q_{gd} | V _{GS} = 10 V, V _{DS} = 0.5 V _{DSS} , I _D = 0.5 I _{D25} | 240 | nC | |
| | | 96 | nC | |
| | | 78 | nC | |
| R_{thJC} | | | 0.10 | K/W |
| R_{thCS} | | 0.13 | | K/W |

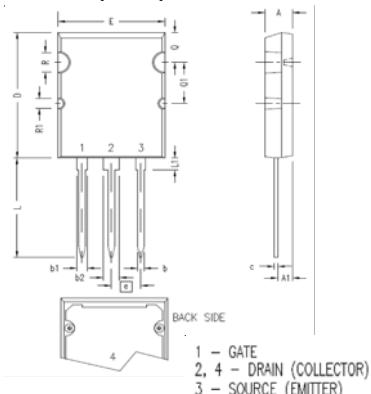
Source-Drain Diode**Characteristic Values**(T_J = 25°C, unless otherwise specified)**Symbol** **Test Conditions**

min. | typ. | max.

| | | | | |
|---|--|--|-----|----|
| I_s | V _{GS} = 0 V | | 100 | A |
| I_{SM} | Repetitive | | 250 | A |
| V_{SD} | I _F = I _s , V _{GS} = 0 V, Note 1 | | 1.5 | V |
| t_{rr} Q_{RM} I_{RM} | I _F = 25A, -di/dt = 100 A/μs V _R = 100V | | 200 | ns |
| | | | 0.6 | μC |
| | | | 6.0 | A |

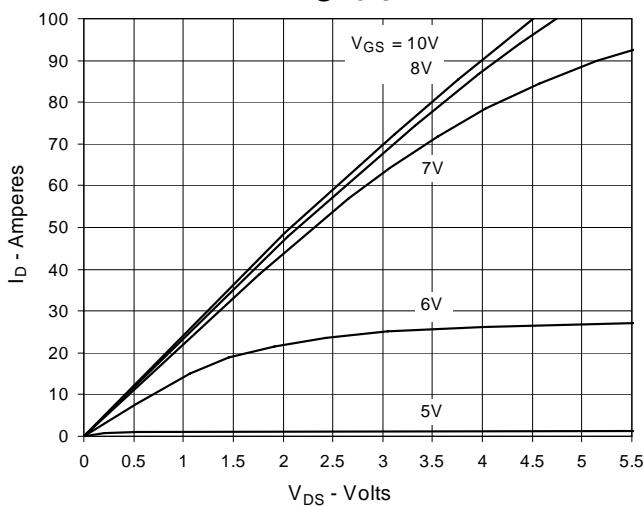
Notes:

1. Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 %

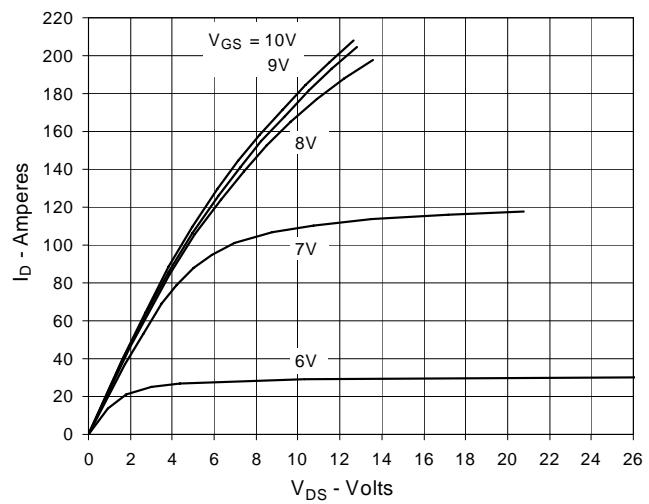
PLUS264™ (IXFB) Outline

| SYM | INCHES | | MILLIMETERS | |
|-----|----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | .185 | .209 | 4.70 | 5.31 |
| A1 | .102 | .118 | 2.59 | 3.00 |
| b | .037 | .055 | 0.94 | 1.40 |
| b1 | .087 | .102 | 2.21 | 2.59 |
| b2 | .110 | .126 | 2.79 | 3.20 |
| c | .017 | .029 | 0.43 | 0.74 |
| D | 1.007 | 1.047 | 25.58 | 26.59 |
| E | .760 | .799 | 19.30 | 20.29 |
| e | .215 BSC | | 5.46 BSC | |
| L | .779 | .842 | 19.79 | 21.39 |
| L1 | .087 | .102 | 2.21 | 2.59 |
| Q | .240 | .256 | 6.10 | 6.50 |
| Q1 | .330 | .346 | 8.38 | 8.79 |
| ØR | .155 | .187 | 3.94 | 4.75 |
| ØR1 | .085 | .093 | 2.16 | 2.36 |

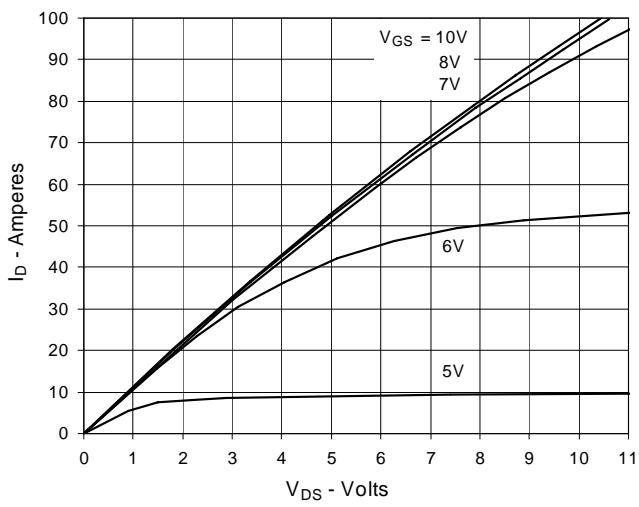
**Fig. 1. Output Characteristics
@ 25°C**



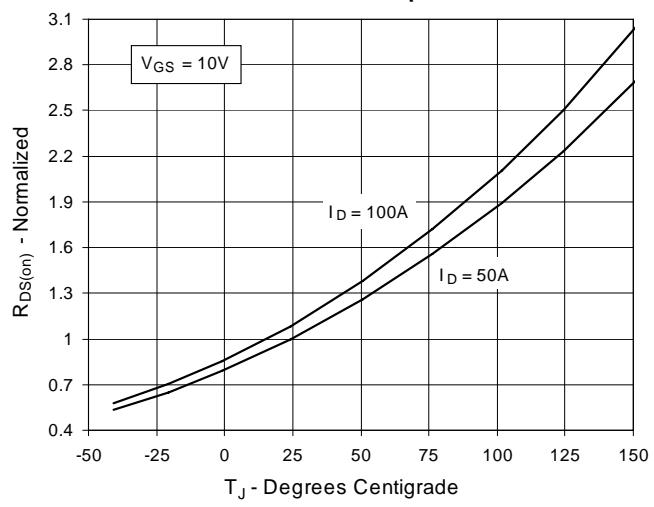
**Fig. 2. Extended Output Characteristics
@ 25°C**



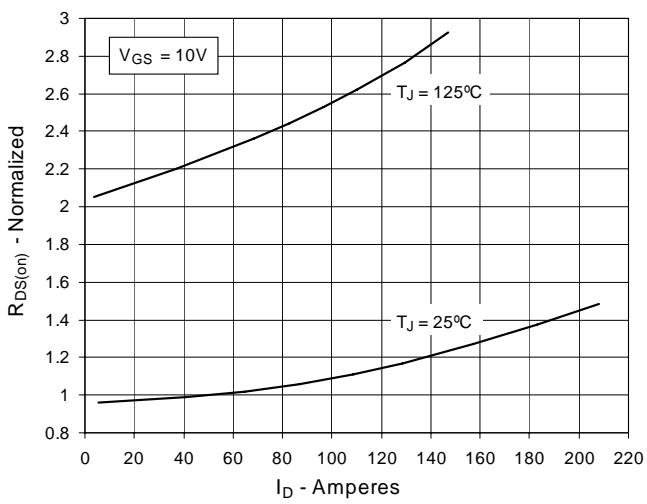
**Fig. 3. Output Characteristics
@ 125°C**



**Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 50A$ Value
vs. Junction Temperature**



**Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 50A$ Value
vs. Drain Current**



**Fig. 6. Maximum Drain Current vs.
Case Temperature**

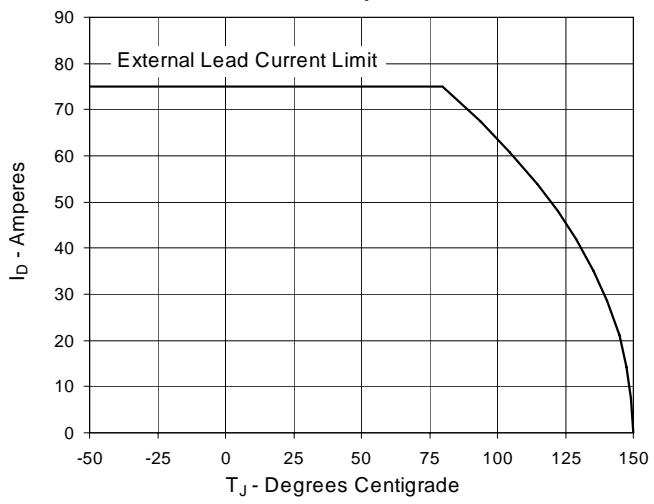


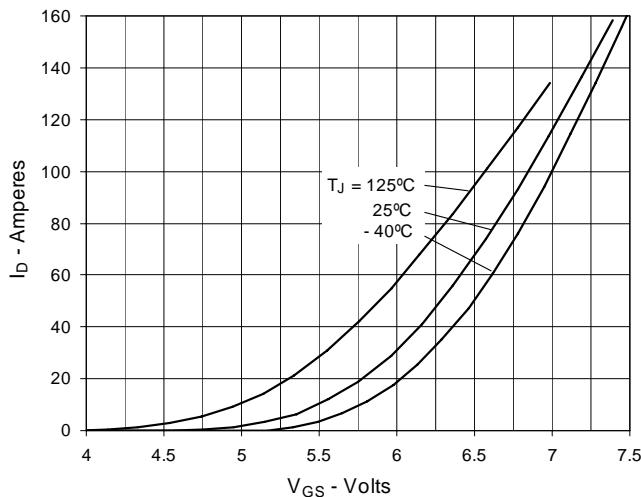
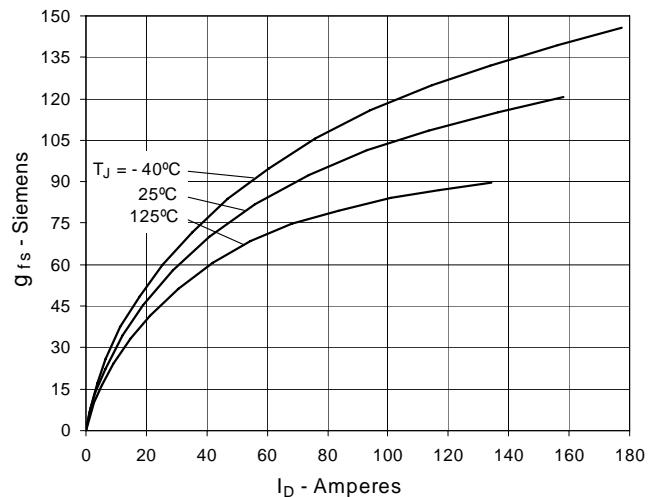
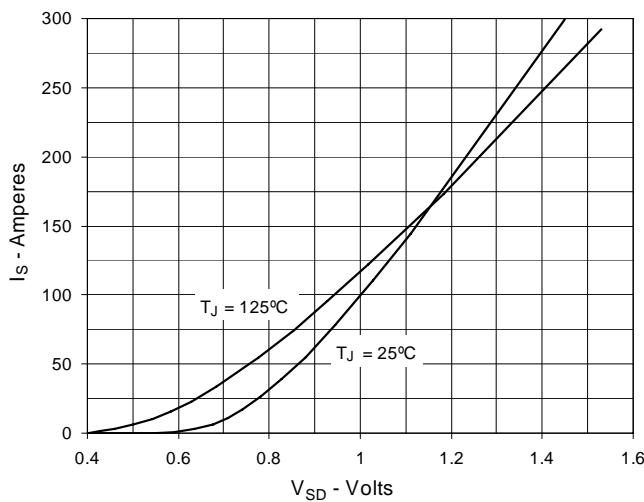
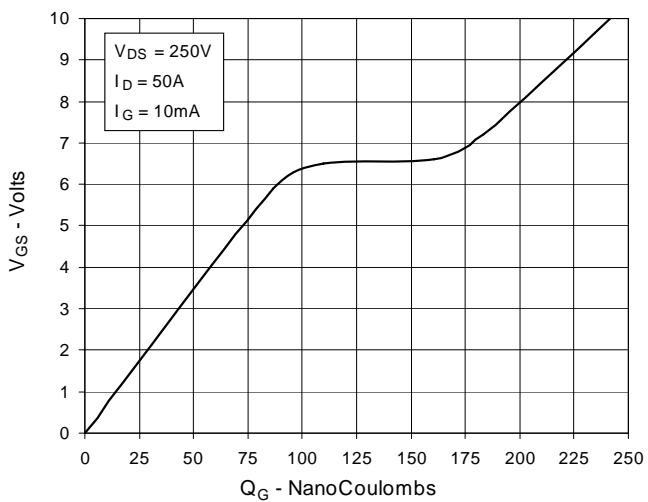
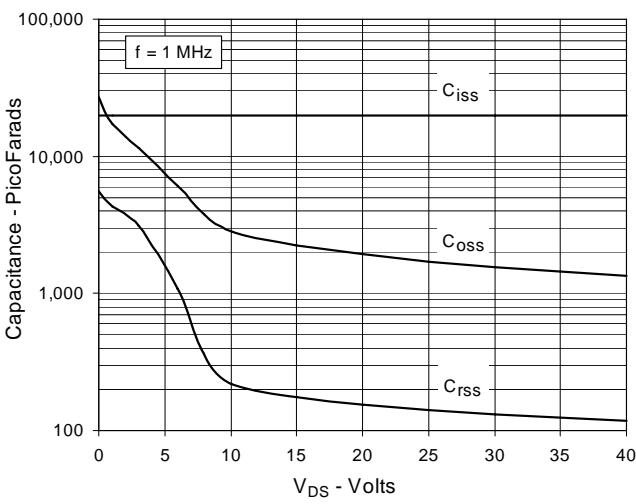
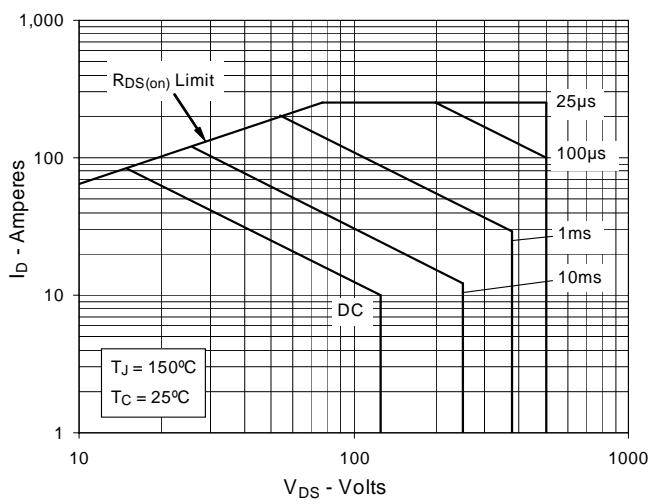
Fig. 7. Input Admittance

Fig. 8. Transconductance

Fig. 9. Forward Voltage Drop of Intrinsic Diode

Fig. 10. Gate Charge

Fig. 11. Capacitance

Fig. 12. Forward-Bias Safe Operating Area


Fig. 13. Maximum Transient Thermal Resistance